

Features

- AEC-Q101 Qualified
- Split Gate Trench MOSFET Technology
- Excellent Stability And Uniformity
- Moisture Sensitivity Level 1
- Halogen Free."Green"Device^(Note1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

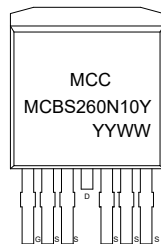
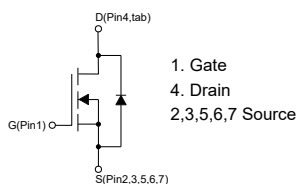
- Operating Junction Temperature Range : -55°C to +175°C
- Storage Temperature Range: -55°C to +175°C
- Thermal Resistance: 40°C/W Junction to Ambient^(Note2)
- Thermal Resistance: 0.4°C/W Junction to Case

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	260
		$T_C=100^\circ\text{C}$	184
Pulsed Drain Current ^(Note3)	I_{DM}	1040	A
Total Power Dissipation ^(Note4)	P_D	375	W
Avalanche Energy ^(Note5)	E_{AS}	1122	mJ

Note:

1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.
3. Repetitive rating; pulse width limited by max. junction temperature.
4. P_D is based on max. junction temperature, using junction-case thermal resistance.
5. $T_J=25^\circ\text{C}$, $V_{DD}=50\text{V}$, $V_{GS}=10\text{V}$, $L=0.5\text{mH}$.

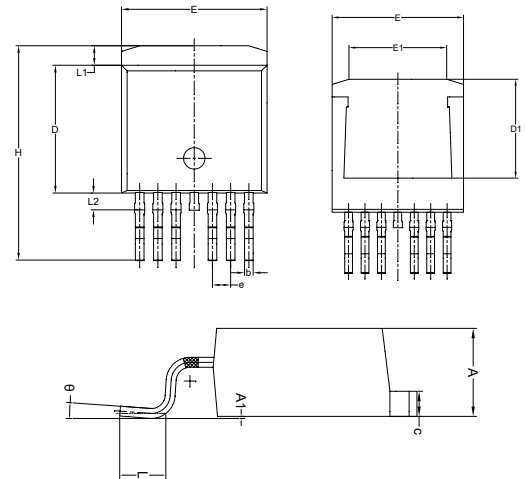
Internal Structure and Marking Code



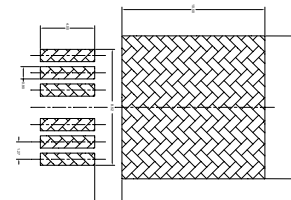
4 codes in total
YY is the year
WW is the week

N-CHANNEL MOSFET

TO-263-7



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.167	0.183	4.24	4.64	
A1	0.000	0.010	0.00	0.25	
b	0.020	0.035	0.50	0.90	
c	0.045	0.055	1.15	1.40	
D	0.347	0.364	8.82	9.25	
D1	0.270		6.86		
E	0.392	0.408	9.96	10.36	
E1	0.256	0.310	6.50	7.89	
e	0.050		1.27		TYP.
H	0.575	0.625	14.61	15.88	
L	0.070	0.110	1.78	2.79	
L1	0.039	0.056	0.98	1.42	
L2		0.070		1.78	
θ			0°	8°	



Electrical Characteristics @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=1mA$	100			V
Gate-Source Leakage Current	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=80V, V_{GS}=0V$			1	μA
Gate-Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	2.8	4	V
Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=30A$		1.4	1.8	m Ω
Gate Resistance	R_g	f=1 MHz, Open drain		1.4		Ω
Diode Characteristics						
Continuous Body Diode Current	I_S				260	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=30A$			1.3	V
Reverse Recovery Time	t_{rr}	$I_S=130A, di/dt=100A/\mu s$		89.2		ns
Reverse Recovery Charge	Q_{rr}			156.8		nC
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS}=30V, V_{GS}=0V, f=1MHz$		10589		pF
Output Capacitance	C_{oss}			5099		
Reverse Transfer Capacitance	C_{rss}			318		
Total Gate Charge	Q_g	$V_{DS}=50V, V_{GS}=10V, I_D=130A$		161		nC
Gate-Source Charge	Q_{gs}			38		
Gate-Drain Charge	Q_{gd}			50		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=50V, V_{GS}=10V, R_G=6\Omega, I_{DS}=130A$		41		ns
Turn-On Rise Time	t_r			174.5		
Turn-Off Delay Time	$t_{d(off)}$			109		
Turn-Off Fall Time	t_f			123.7		

Curve Characteristics

Fig. 1 - Typical Output Characteristics

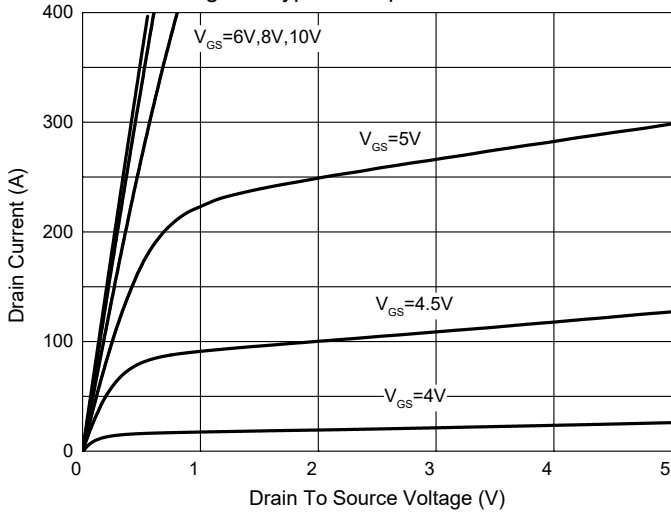


Fig. 2 - Transfer Characteristics

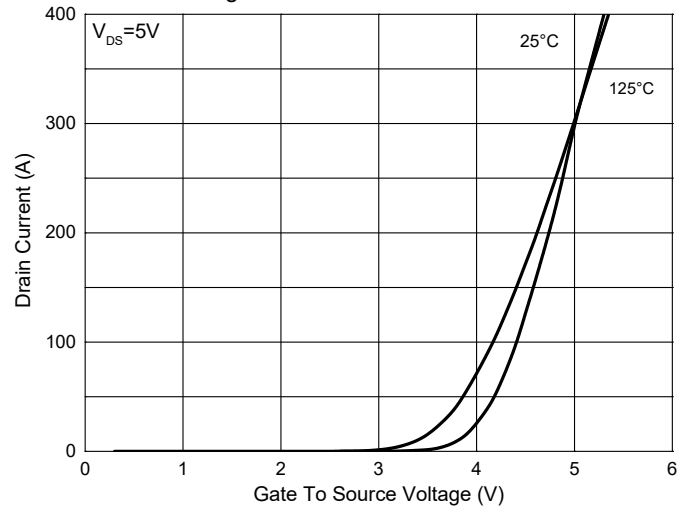


Fig. 3 - $R_{DS(ON)}$ — V_{GS}

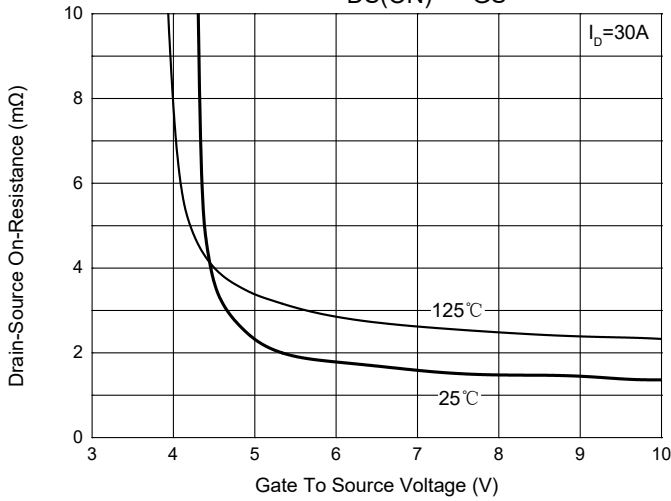


Fig. 4 - $R_{DS(ON)}$ — I_D

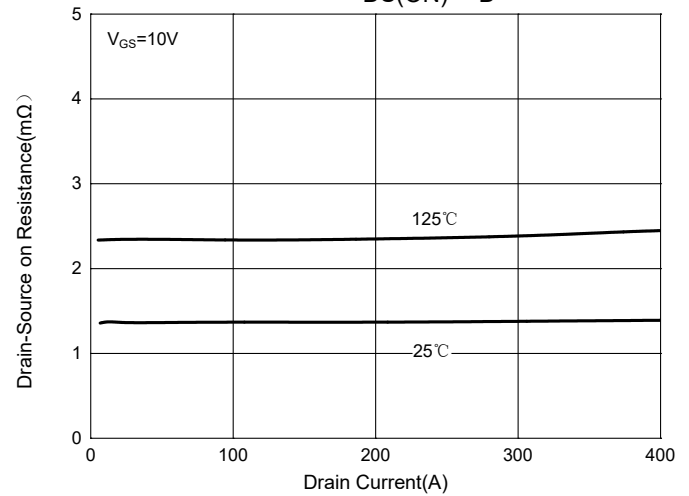


Fig. 5 - Capacitance Characteristics

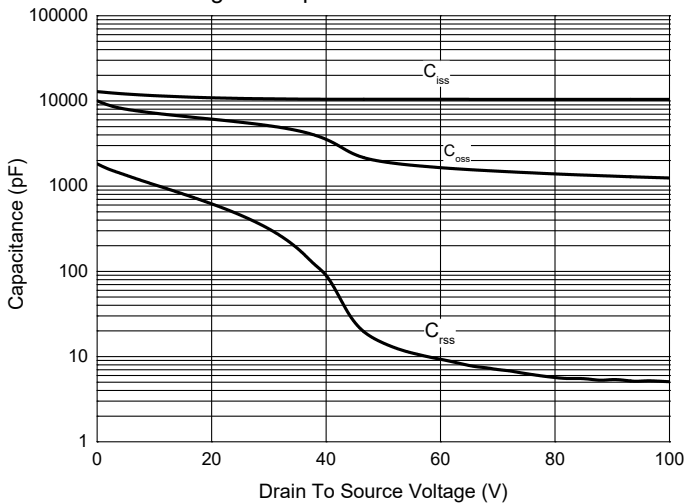
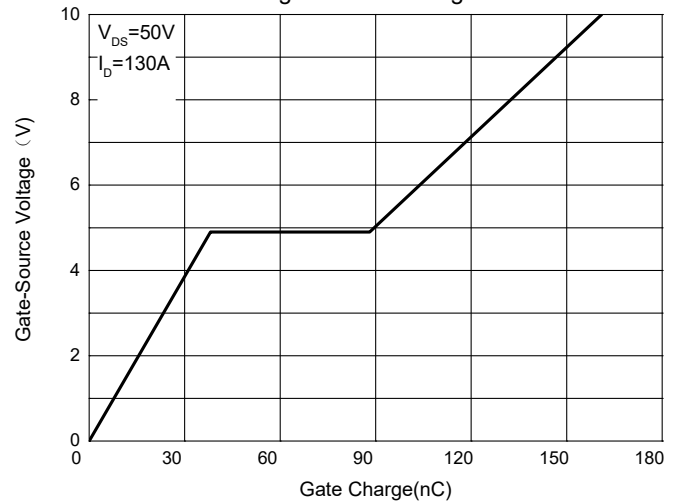


Fig. 6 - Gate Charge



Curve Characteristics

Fig. 7 - Normalized Threshold Voltage

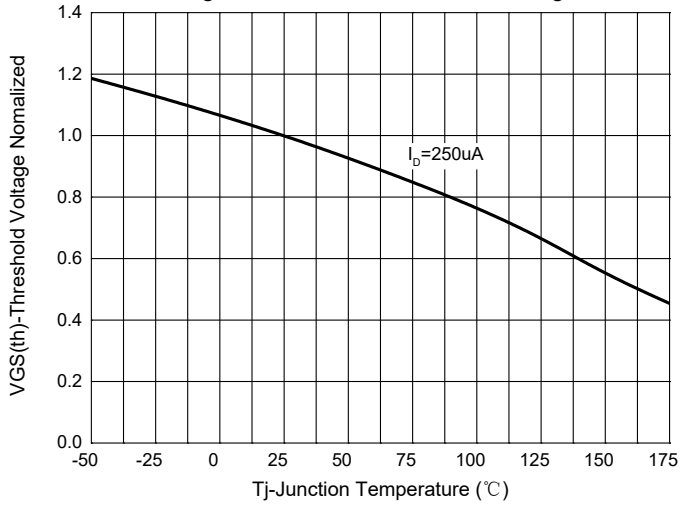


Fig.8-Normalized On Resistance Characteristics

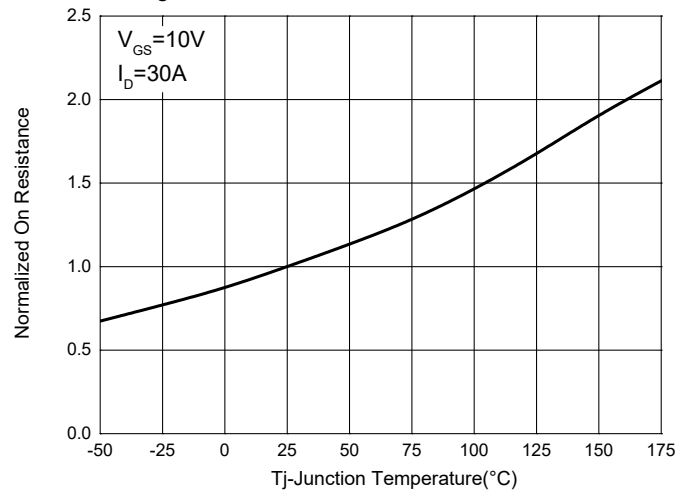


Fig.9 - IS—VSD

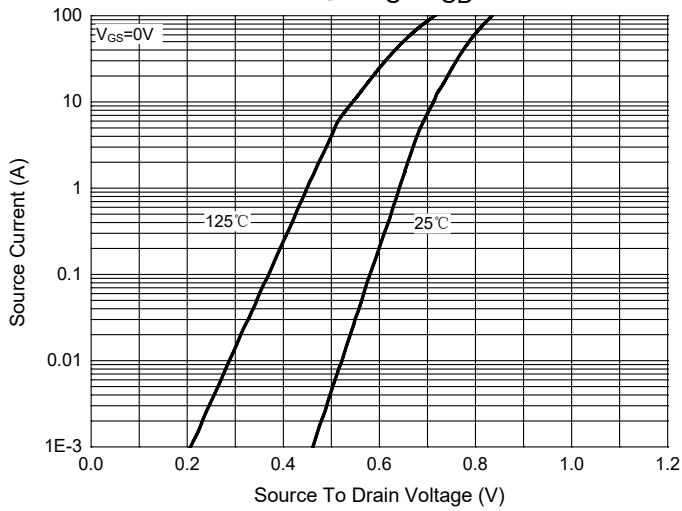


Fig. 10 - Drain Current

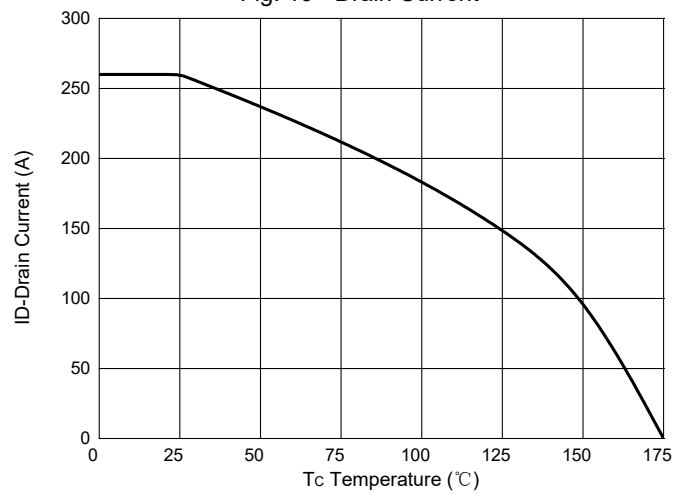
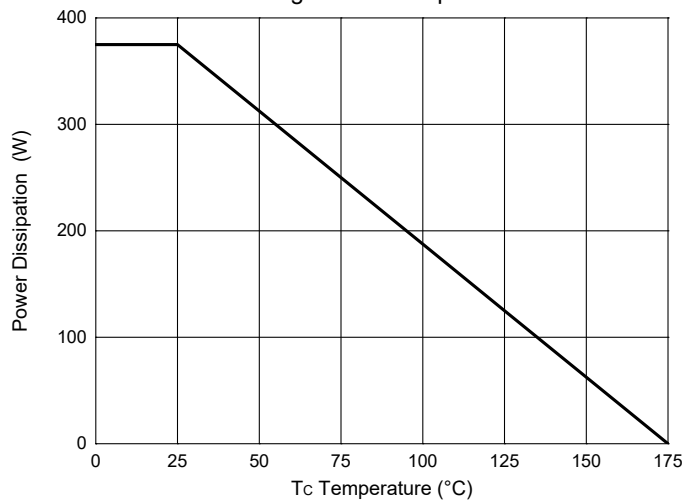


Fig.11-PD Dissipation



Curve Characteristics

Fig. 12 - Safe Operation Area

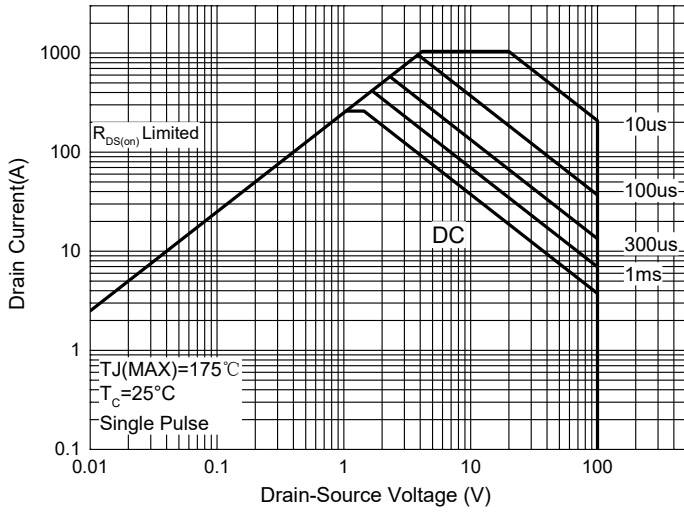
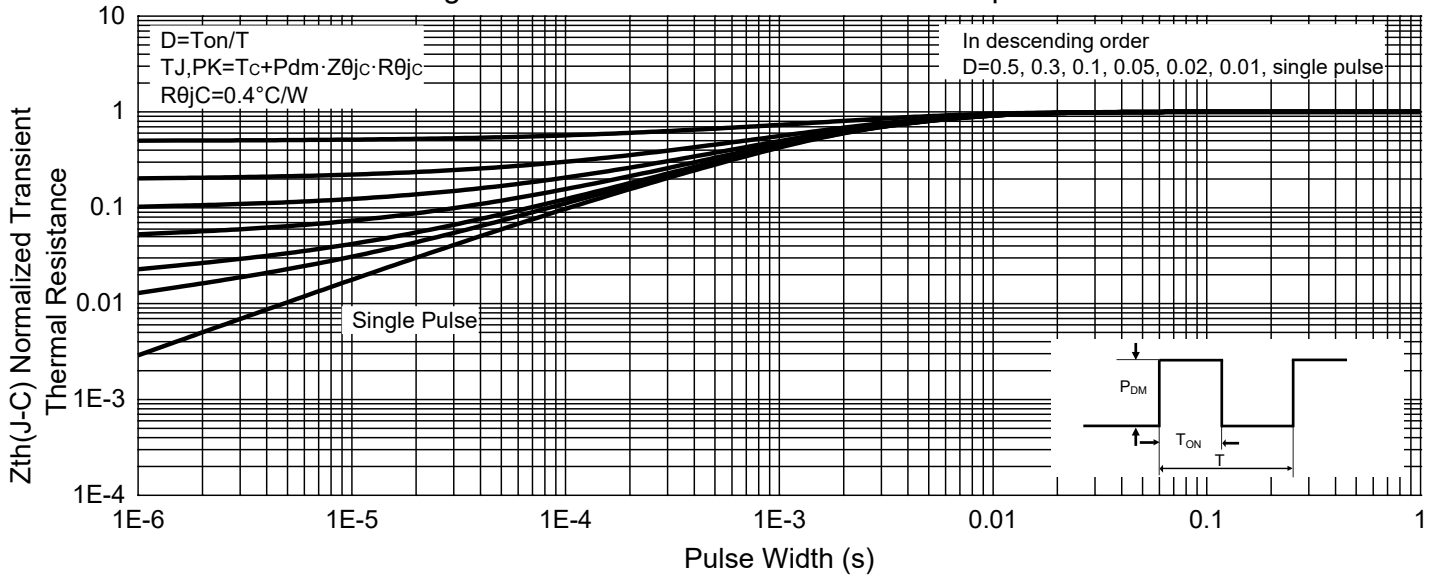


Fig. 13 - Normalized Transient Thermal Impedance



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel: 800pcs/Reel

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